

# DATA SHEET

## **BSP130**

**N-channel enhancement mode  
vertical D-MOS transistor**

Product specification  
File under Discrete Semiconductors, SC13b

April 1995

# N-channel enhancement mode vertical D-MOS transistor

**BSP130**

**FEATURES**

- Direct interface to C-MOS, TTL, etc.
- High-speed switching
- No secondary breakdown.

**DESCRIPTION**

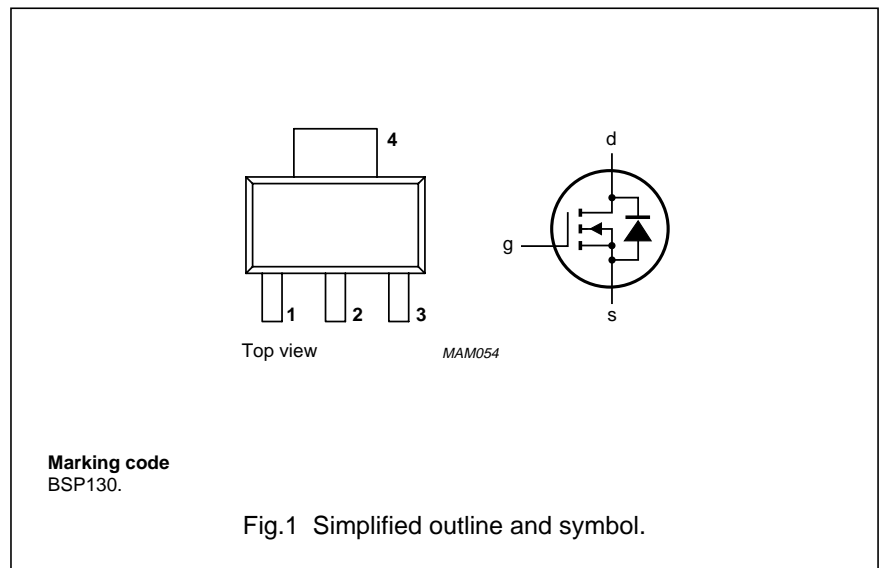
N-channel enhancement mode vertical D-MOS transistor in a SOT223 envelope, intended for use as a line current interruptor in telephone sets and for applications in relay, high-speed and line transformer drivers.

**QUICK REFERENCE DATA**

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
$V_{DS}$	drain-source voltage		–	300	V
$I_D$	DC drain current		–	300	mA
$P_{tot}$	total power dissipation	up to $T_{amb} = 25\text{ °C}$	–	1.5	W
$\pm V_{GS0}$	gate-source voltage	open drain	–	20	V
$R_{DS(on)}$	drain-source on-resistance	$I_D = 250\text{ mA};$ $V_{GS} = 10\text{ V}$	–	8	$\Omega$
$V_{GS(off)}$	gate-source cut-off voltage	$I_D = 1\text{ mA};$ $V_{DS} = V_{GS}$	0.8	2	V

**PINNING - SOT223**

PIN	DESCRIPTION
1	gate
2	drain
3	source
4	drain



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## LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
$V_{DS}$	drain-source voltage		–	300	V
$\pm V_{GSO}$	gate-source voltage	open drain	–	20	V
$I_D$	DC drain current		–	300	mA
$I_{DM}$	peak drain current		–	1.4	A
$P_{tot}$	total power dissipation	up to $T_{amb} = 25\text{ °C}$ ; note 1	–	1.5	W
$T_{stg}$	storage temperature		–65	+150	°C
$T_j$	junction temperature		–	150	°C

## THERMAL RESISTANCE

SYMBOL	PARAMETER	THERMAL RESISTANCE
$R_{th\ j-a}$	from junction to ambient; note 1	83.3 K/W

### Note

- Device mounted on an epoxy printed-circuit board, 40 x 40 x 1.5 mm, mounting pad for the drain tab minimum 6 cm<sup>2</sup>.

## STATIC CHARACTERISTICS

$T_j = 25\text{ °C}$  unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$V_{(BR)DSS}$	drain-source breakdown voltage	$I_D = 10\ \mu\text{A}$ ; $V_{GS} = 0$	300	–	–	V
$\pm I_{GSS}$	gate-source leakage current	$\pm V_{GS} = 20\text{ V}$ ; $V_{DS} = 0$	–	–	100	nA
$V_{GS(th)}$	gate-source threshold voltage	$I_D = 1\text{ mA}$ ; $V_{DS} = V_{GS}$	0.8	–	2	V
$R_{DS(on)}$	drain-source on-resistance	$I_D = 20\text{ mA}$ ; $V_{GS} = 2.4\text{ V}$	–	7.9	14	$\Omega$
		$I_D = 250\text{ mA}$ ; $V_{GS} = 10\text{ V}$	–	6.7	8	$\Omega$
$I_{DSS}$	drain-source leakage current	$V_{DS} = 240\text{ V}$ ; $V_{GS} = 0$	–	–	100	nA
$ Y_{fs} $	transfer admittance	$I_D = 250\text{ mA}$ ; $V_{DS} = 25\text{ V}$	200	380	–	mS
$C_{iss}$	input capacitance	$V_{DS} = 25\text{ V}$ ; $V_{GS} = 0$ ; $f = 1\text{ MHz}$	–	57	90	pF
$C_{oss}$	output capacitance	$V_{DS} = 25\text{ V}$ ; $V_{GS} = 0$ ; $f = 1\text{ MHz}$	–	15	30	pF
$C_{rss}$	feedback capacitance	$V_{DS} = 25\text{ V}$ ; $V_{GS} = 0$ ; $f = 1\text{ MHz}$	–	2.6	15	pF
<b>Switching times (see Figs 2 and 3)</b>						
$t_{on}$	turn-on time	$I_D = 250\text{ mA}$ ; $V_{DD} = 50\text{ V}$ ; $V_{GS} = 0\text{ to }10\text{ V}$	–	2.5	10	ns
$t_{off}$	turn-off time	$I_D = 250\text{ mA}$ ; $V_{DD} = 50\text{ V}$ ; $V_{GS} = 10\text{ to }0\text{ V}$	–	17	30	ns

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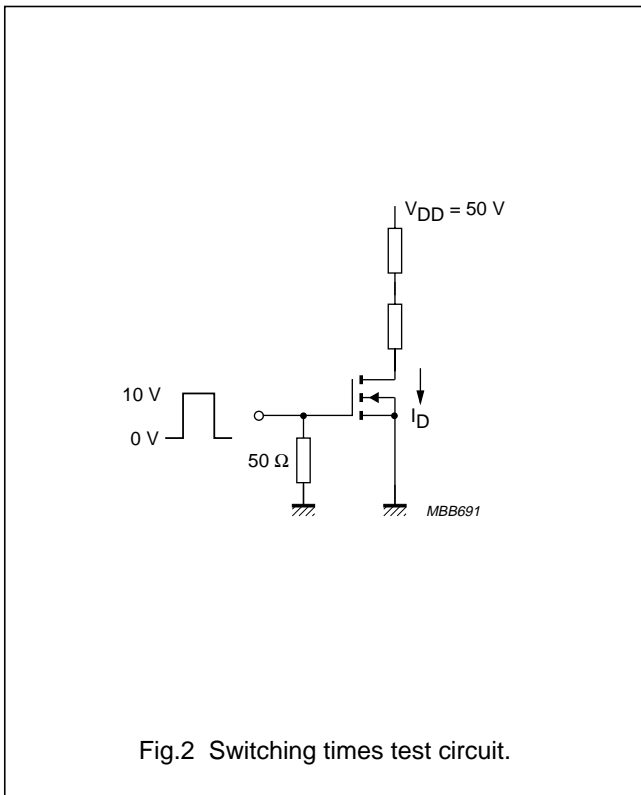


Fig.2 Switching times test circuit.

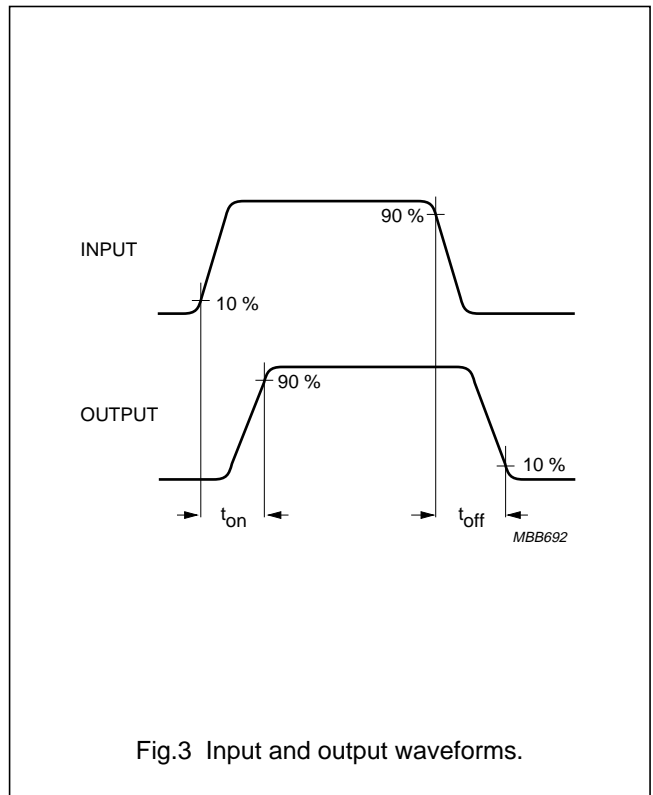


Fig.3 Input and output waveforms.

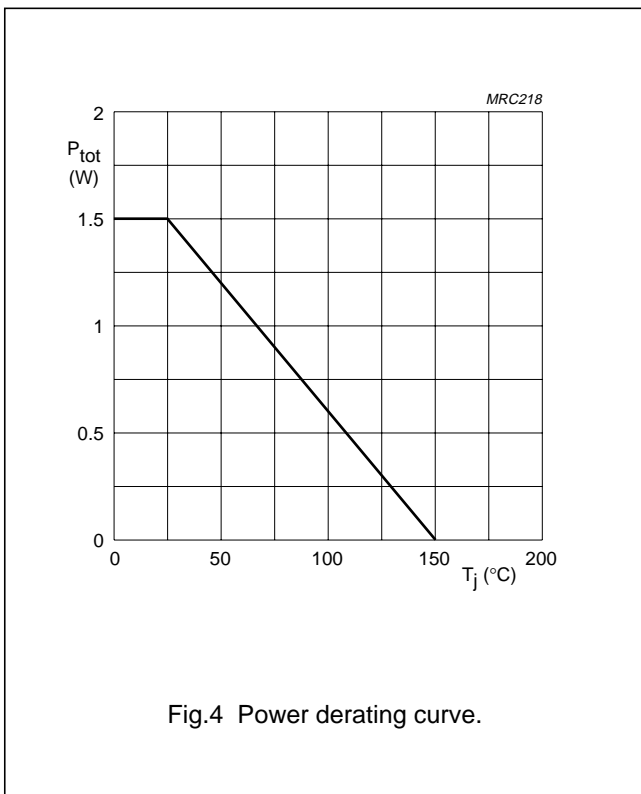
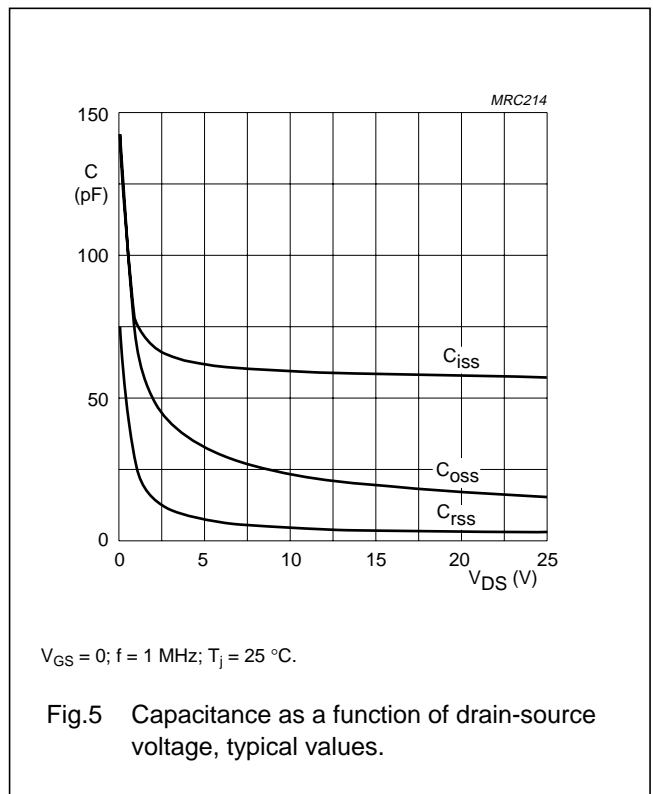


Fig.4 Power derating curve.

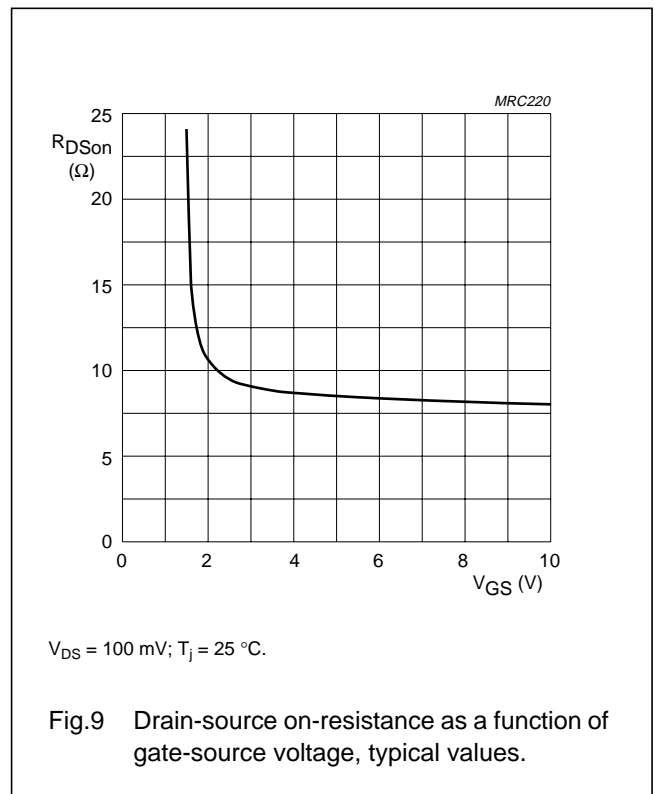
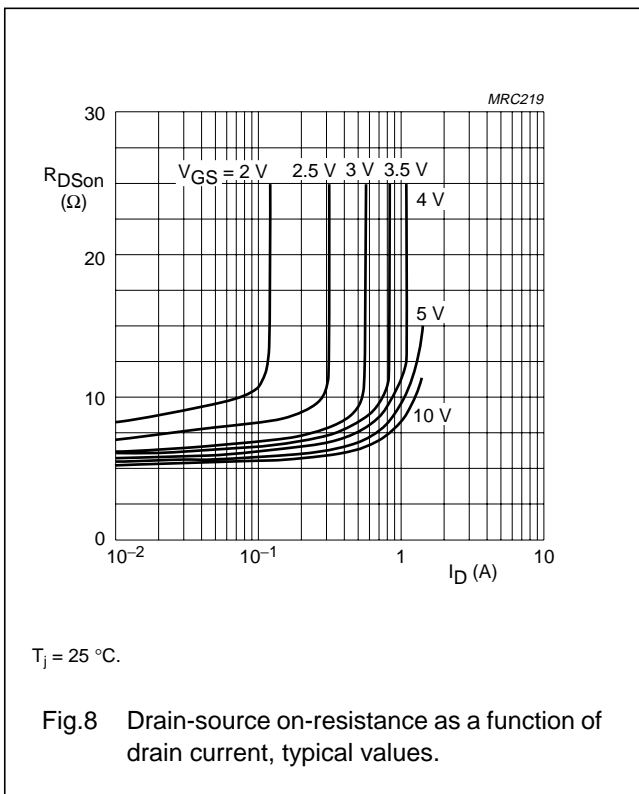
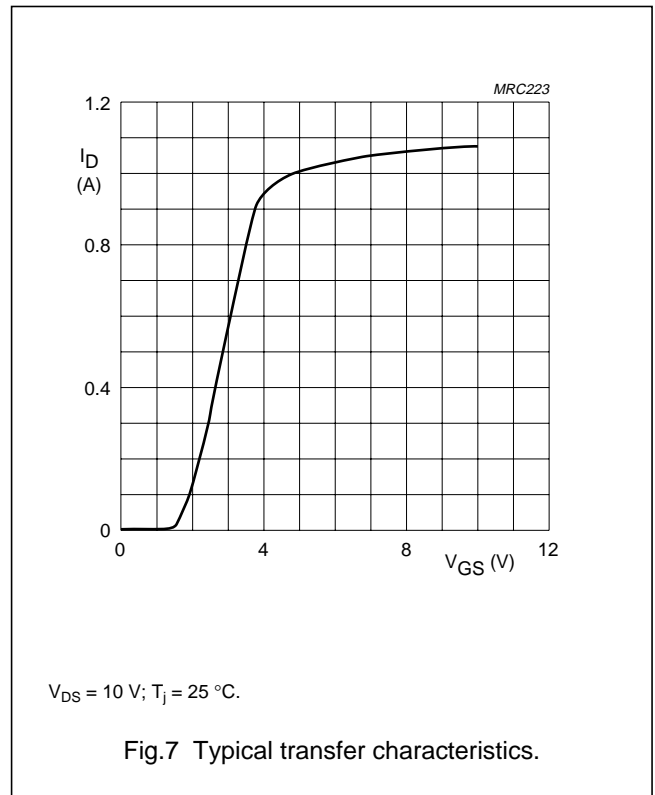
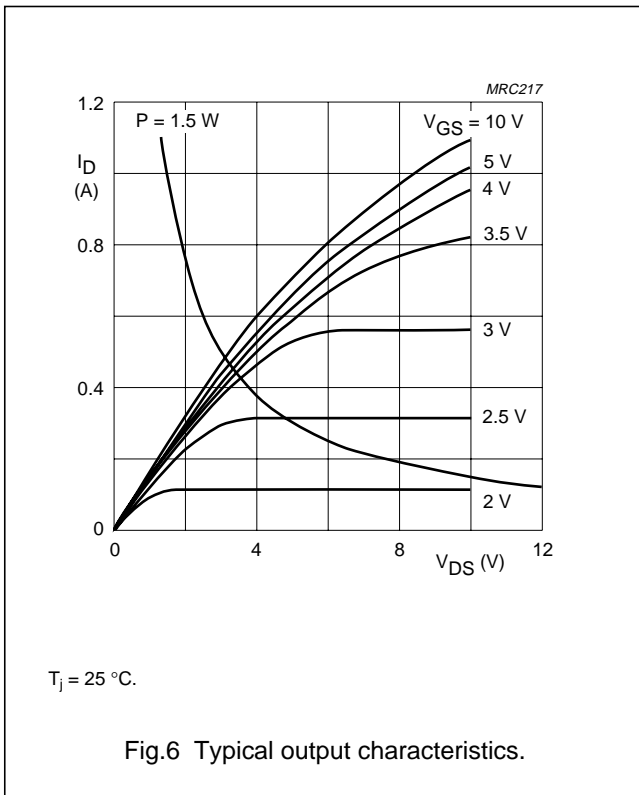


V<sub>GS</sub> = 0; f = 1 MHz; T<sub>j</sub> = 25 °C.

Fig.5 Capacitance as a function of drain-source voltage, typical values.

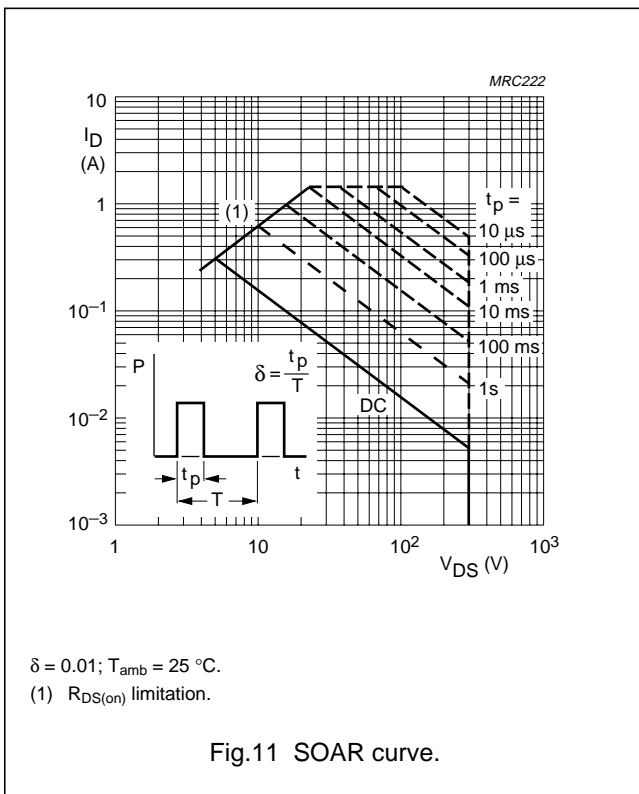
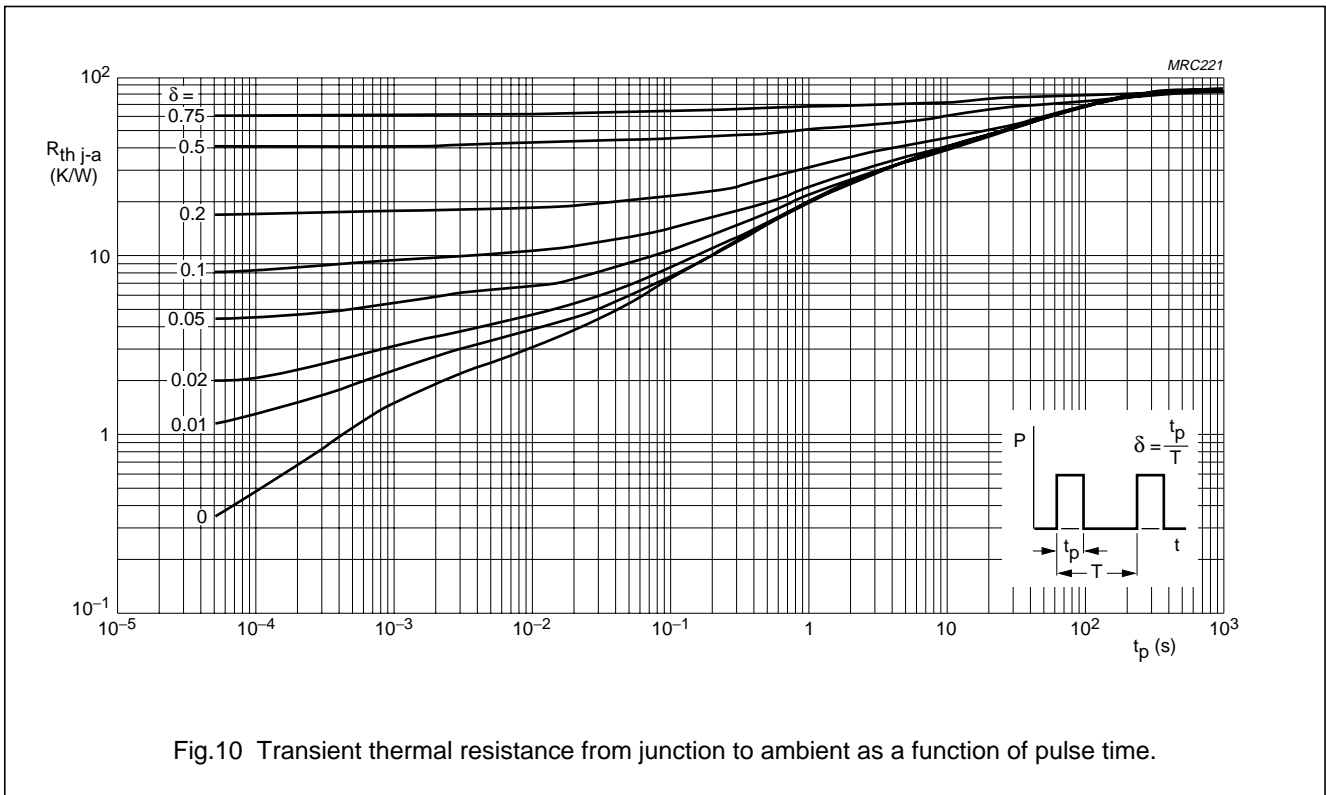
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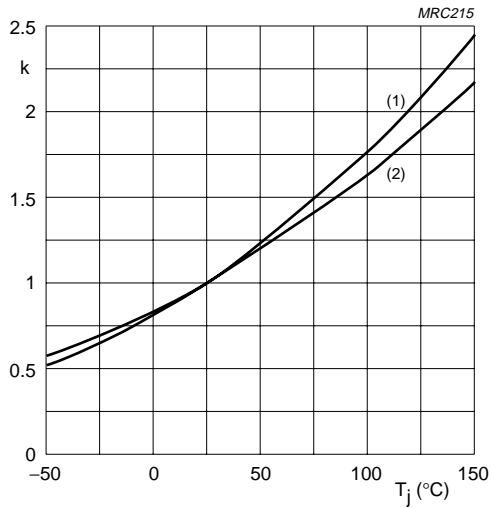
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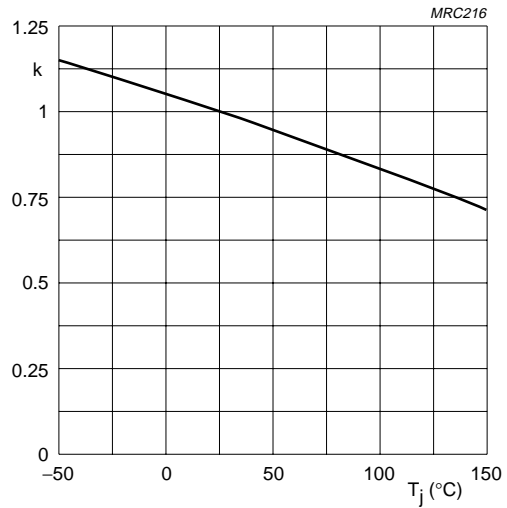
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$$k = \frac{R_{DS(on)} \text{ at } T_j}{R_{DS(on)} \text{ at } 25^\circ\text{C}}$$

Typical R<sub>DS(on)</sub>;  
(1) I<sub>D</sub> = 250 mA; V<sub>GS</sub> = 10 V.  
(2) I<sub>D</sub> = 20 mA; V<sub>GS</sub> = 2.4 V.

Fig.12 Temperature coefficient of drain-source on-resistance.



$$k = \frac{V_{GS(th)} \text{ at } T_j}{V_{GS(th)} \text{ at } 25^\circ\text{C}}$$

Typical V<sub>GS(th)</sub> at 1 mA.

Fig.13 Temperature coefficient of gate-source threshold voltage.

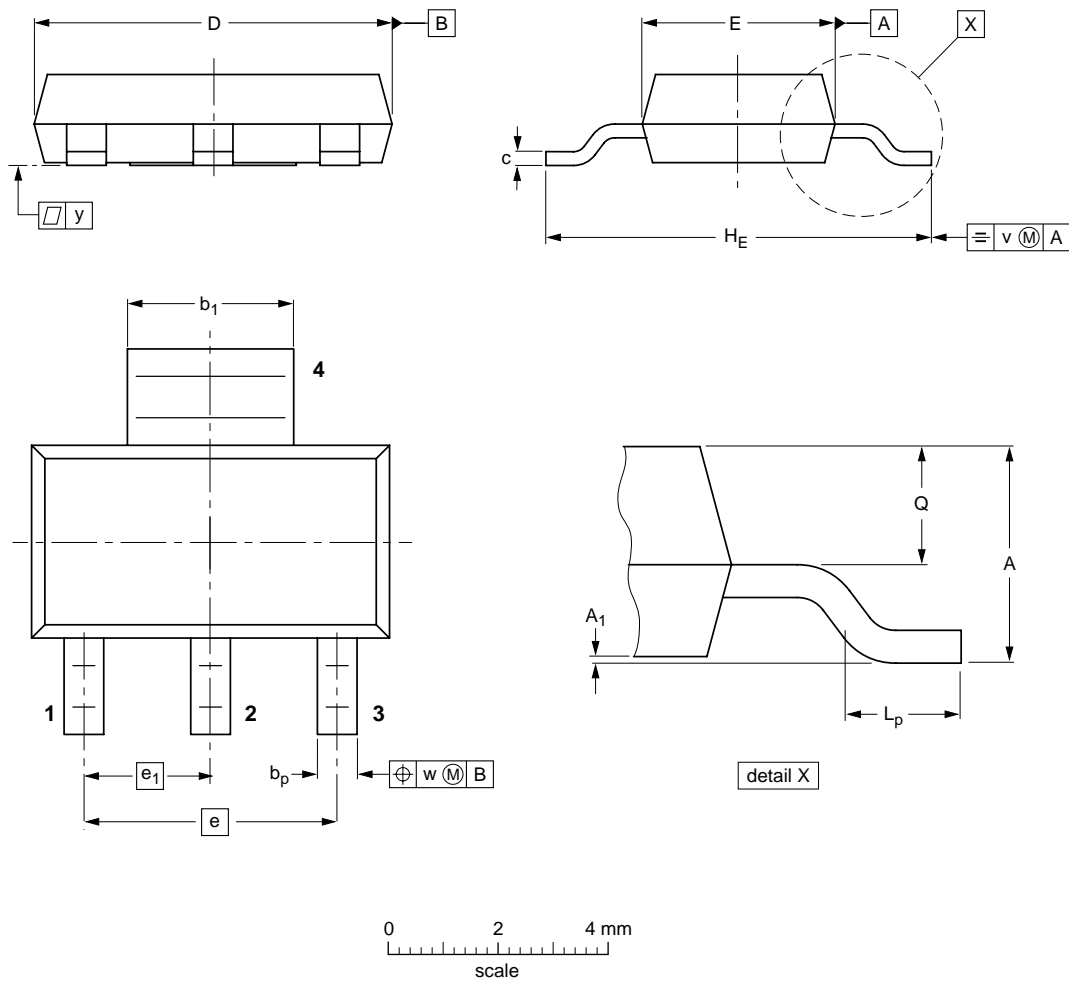
# N-channel enhancement mode vertical D-MOS transistor

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## PACKAGE OUTLINE

Plastic surface mounted package; collector pad for good heat transfer; 4 leads

SOT223



**DIMENSIONS (mm are the original dimensions)**

UNIT	A	A <sub>1</sub>	b <sub>p</sub>	b <sub>1</sub>	c	D	E	e	e <sub>1</sub>	H <sub>E</sub>	L <sub>p</sub>	Q	v	w	y
mm	1.8 1.5	0.10 0.01	0.80 0.60	3.1 2.9	0.32 0.22	6.7 6.3	3.7 3.3	4.6	2.3	7.3 6.7	1.1 0.7	0.95 0.85	0.2	0.1	0.1

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT223						96-11-11 97-02-28



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**BSP130****DEFINITIONS**

<b>Data sheet status</b>	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
<b>Application information</b>	
Where application information is given, it is advisory and does not form part of the specification.	

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**NOTES**

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